

# **PCA8576C**

## Automotive LCD driver for low multiplex rates

Rev. 3 — 8 April 2015

Product data sheet

## 1. General description

The PCA8576C is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD)<sup>1</sup> with low multiplex rates. It generates the drive signals for any static or multiplexed LCD containing up to four backplanes and up to 40 segments and can easily be cascaded for larger LCD applications. The PCA8576C is compatible with most microcontrollers and communicates via the two-line bidirectional I<sup>2</sup>C-bus. Communication overheads are minimized by a display RAM with auto-incremented addressing and by hardware subaddressing.

For a selection of NXP LCD segment drivers, see <u>Table 21 on page 45</u>.

## 2. Features and benefits

- AEC-Q100 compliant for automotive applications
- Single-chip LCD controller and driver
- 40 segment drives:
  - Up to twenty 7-segment alphanumeric characters
  - ◆ Up to ten 14-segment alphanumeric characters
  - Any graphics of up to 160 elements
- Versatile blinking modes
- No external components required (even in multiple device applications)
- Selectable backplane drive configuration: static, 2, 3, or 4 backplane multiplexing
- Selectable display bias configuration: static, ½, or ½
- Internal LCD bias generation with voltage-follower buffers
- 40 × 4-bit RAM for display data storage
- Auto-incremented display data loading across device subaddress boundaries
- Display memory bank switching in static and duplex drive modes
- Wide logic LCD supply range:
  - ◆ From 2 V for low-threshold LCDs
  - ◆ Up to 6 V for guest-host LCDs and high-threshold twisted nematic LCDs
- Low power consumption
- May be cascaded for large LCD applications (up to 2560 segments possible)
- No external components
- Separate or combined LCD and logic supplies
- Optimized pinning for plane wiring in both and multiple PCA8576C applications
- Power-saving mode for extremely low power consumption in battery-operated and telephone applications

<sup>1.</sup> The definition of the abbreviations and acronyms used in this data sheet can be found in Section 19.



## **Automotive LCD driver for low multiplex rates**

## 3. Ordering information

Table 1. Ordering information

Type number	Package					
	Name	Description	Version			
PCA8576CH	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2			
PCA8576CT	VSO56	plastic very small outline package, 56 leads	SOT190-1			

## 3.1 Ordering options

Table 2. Ordering options

Product type number		Orderable part number	IC revision	Delivery form
PCA8576CH/Q900/1	935290244157	PCA8576CH/Q900,157	1	tray pack
	935290244118	PCA8576CH/Q900/1,1	1	tape and reel, 13 inch
PCA8576CT/Q900/1	935301673518	PCA8576CT/Q900/1Y	1	tape and reel, 13 inch

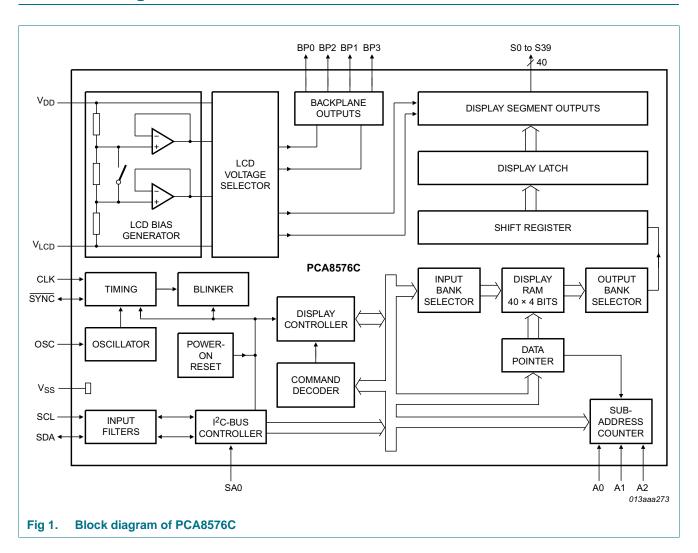
## 4. Marking

Table 3. Marking codes

Type number	Marking code
PCA8576CH/Q900/1	PCA8576CQ900
PCA8576CT/Q900/1	PCA8576CT/Q

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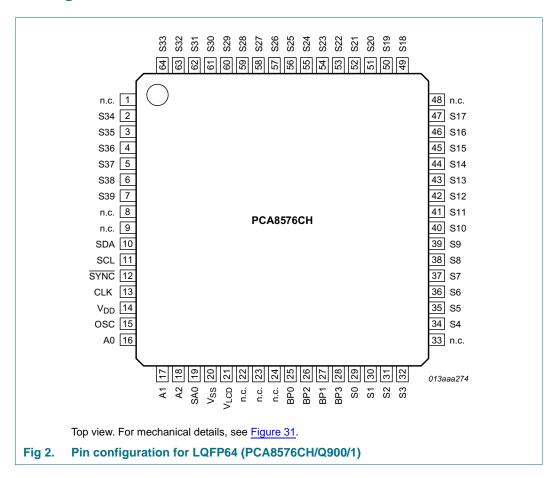
## 5. Block diagram



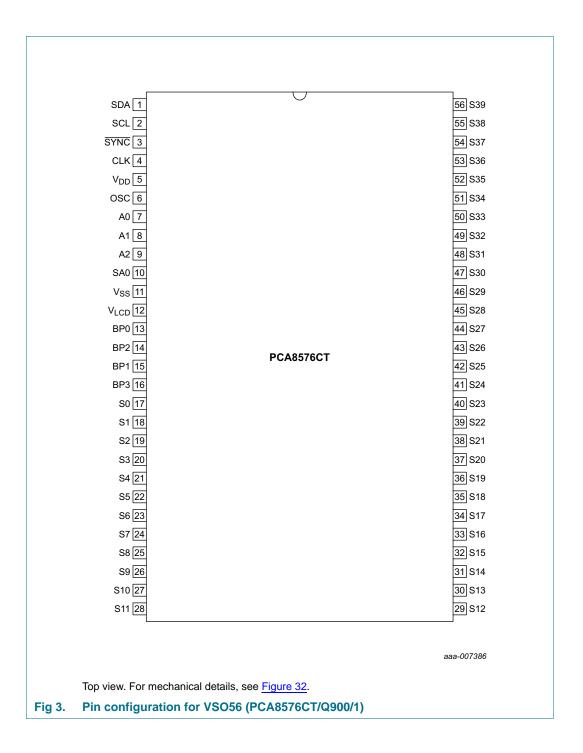
## Automotive LCD driver for low multiplex rates

## 6. Pinning information

## 6.1 Pinning



## Automotive LCD driver for low multiplex rates



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## **Automotive LCD driver for low multiplex rates**

## 6.2 Pin description

Pin description Table 4.

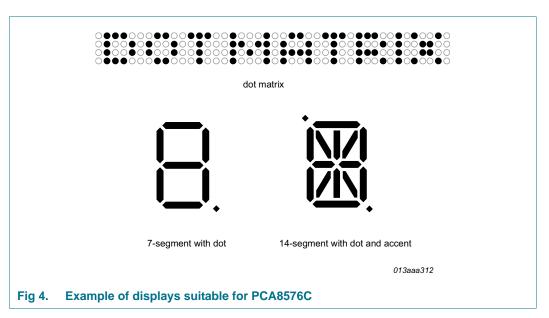
Input or input/output pins must always be at a defined level ( $V_{SS}$  or  $V_{DD}$ ) unless otherwise specified.

Symbol	Pin		Description			
	LQFP64 (PCA8576CH/Q900/1)	VSO56 (PCA8576CT)	Туре			
SDA	10	1	input/output	I <sup>2</sup> C-bus serial data input and output		
SCL	11	2	input	I <sup>2</sup> C-bus serial clock input		
SYNC	12	3	input/output	cascade synchronization input and output		
CLK	13	4	input/output	external clock input/output		
$V_{DD}$	14	5	supply	supply voltage		
OSC	15	6	input	internal oscillator enable input		
A0 to A2	16 to 18	7 to 9	input	subaddress inputs		
SA0	19	10	input	I <sup>2</sup> C-bus address input; bit 0		
V <sub>SS</sub>	20	11	supply	ground supply voltage		
$V_{LCD}$	21	12	supply	LCD supply voltage		
BP0, BP2, BP1, BP3	25 to 28	13 to 16	output	LCD backplane outputs		
S0 to S39	2 to 7, 29 to 32, 34 to 47, 49 to 64	17 to 56	output	LCD segment outputs		
n.c.	1, 8, 9, 22 to 24, 33, 48	-	-	not connected; do not connect and do not use as feed through		

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## 7. Functional description

The PCA8576C is a versatile peripheral device designed to interface between any microprocessor or microcontroller to a wide variety of LCD segment or dot matrix displays (see <a href="Figure 4">Figure 4</a>). It can directly drive any static or multiplexed LCD containing up to four backplanes and up to 40 segments.

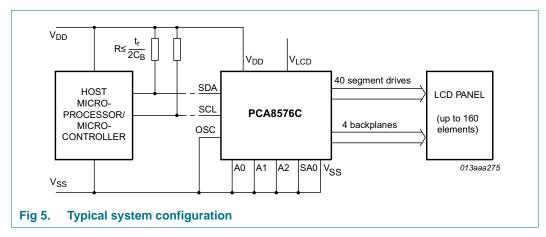


The possible display configurations of the PCA8576C depend on the number of active backplane outputs required. A selection of display configurations is shown in <u>Table 5</u>. All of these configurations can be implemented in the typical system shown in <u>Figure 5</u>.

Table 5. Selection of possible display configurations

Number of						
Backplanes	Icons	Digits/Charact	Digits/Characters			
		7-segment	14-segment	Elements		
4	160	20	10	160 dots (4 × 40)		
3	120	15	7	120 dots (3 × 40)		
2	80	10	5	80 dots (2 × 40)		
1	40	5	2	40 dots (1 × 40)		

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The host microprocessor or microcontroller maintains the 2-line I<sup>2</sup>C-bus communication channel with the PCA8576C.

Biasing voltages for the multiplexed LCD waveforms are generated internally, removing the need for an external bias generator. The internal oscillator is selected by connecting pin OSC to  $V_{SS}$ . The only other connections required to complete the system are the power supplies (pins  $V_{DD}$ ,  $V_{SS}$ , and  $V_{LCD}$ ) and the LCD panel selected for the application.

## 7.1 Power-On-Reset (POR)

At power-on the PCA8576C resets to the following starting conditions:

- All backplane and segment outputs are set to V<sub>DD</sub>
- The selected drive mode is 1:4 multiplex with  $\frac{1}{3}$  bias
- · Blinking is switched off
- Input and output bank selectors are reset (as defined in Table 9)
- The I2C-bus interface is initialized
- The data pointer and the subaddress counter are cleared

**Remark:** Do not transfer data on the I<sup>2</sup>C-bus for at least 1 ms after a power-on to allow the reset action to complete.

#### 7.2 LCD bias generator

The full-scale LCD voltage ( $V_{oper}$ ) is obtained from  $V_{DD} - V_{LCD}$ . The LCD voltage may be temperature compensated externally through the  $V_{LCD}$  supply to pin  $V_{LCD}$ .

Fractional LCD biasing voltages are obtained from an internal voltage divider comprising three series resistors connected between  $V_{DD}$  and  $V_{LCD}$ . The center resistor can be switched out of the circuit to provide a  $\frac{1}{2}$  bias voltage level for the 1:2 multiplex configuration.

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## 7.3 LCD voltage selector

The LCD voltage selector coordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the mode-set command from the command decoder. The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of  $V_{LCD}$  and the resulting discrimination ratios (D) are given in Table 6.

Table 6. Biasing characteristics

LCD drive			LCD bias	V <sub>off(RMS)</sub>	$V_{on(RMS)}$	$V_{on(RMS)}$
mode	Backplanes	Levels	configuration	$V_{LCD}$	V <sub>LCD</sub>	$D = \frac{V_{on(RMS)}}{V_{off(RMS)}}$
static	1	2	static	0	1	$\infty$
1:2 multiplex	2	3	1/2	0.354	0.791	2.236
1:2 multiplex	2	4	1/3	0.333	0.745	2.236
1:3 multiplex	3	4	1/3	0.333	0.638	1.915
1:4 multiplex	4	4	1/3	0.333	0.577	1.732

A practical value for  $V_{LCD}$  is determined by equating  $V_{off(RMS)}$  with a defined LCD threshold voltage ( $V_{th}$ ), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode a suitable choice is  $V_{LCD} > 3V_{th}$ .

Multiplex drive modes of 1:3 and 1:4 with  $\frac{1}{2}$  bias are possible but the discrimination and hence the contrast ratios are smaller.

Bias is calculated by  $\frac{1}{1+a}$ , where the values for a are

a = 1 for  $\frac{1}{2}$  bias

a = 2 for  $\frac{1}{3}$  bias

The RMS on-state voltage (V<sub>on(RMS)</sub>) for the LCD is calculated with Equation 1:

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a^2 + 2a + n}{n \times (1 + a)^2}}$$
 (1)

where the values for n are

n = 1 for static drive mode

n = 2 for 1:2 multiplex drive mode

n = 3 for 1:3 multiplex drive mode

n = 4 for 1:4 multiplex drive mode

The RMS off-state voltage (Voff(RMS)) for the LCD is calculated with Equation 2:

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}}$$
 (2)

Discrimination is the ratio of  $V_{on(RMS)}$  to  $V_{off(RMS)}$  and is determined from Equation 3:

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a+1)^2 + (n-1)}{(a-1)^2 + (n-1)}}$$
(3)

PCA8576C

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Using Equation 3, the discrimination for an LCD drive mode of 1:3 multiplex with  $\frac{1}{2}$  bias is  $\sqrt{3} = 1.732$  and the discrimination for an LCD drive mode of 1:4 multiplex with  $\frac{1}{2}$  bias is  $\frac{\sqrt{21}}{3} = 1.528$ .

The advantage of these LCD drive modes is a reduction of the LCD full scale voltage V<sub>LCD</sub> as follows:

- 1:3 multiplex ( $\frac{1}{2}$  bias):  $V_{LCD} = \sqrt{6} \times V_{off(RMS)} = 2.449 V_{off(RMS)}$
- 1:4 multiplex (½ bias):  $V_{LCD} = \left[\frac{(4 \times \sqrt{3})}{3}\right] = 2.309 V_{off(RMS)}$

These compare with  $V_{LCD} = 3V_{off(RMS)}$  when  $\frac{1}{3}$  bias is used.

V<sub>LCD</sub> is sometimes referred as the LCD operating voltage.

#### 7.3.1 Electro-optical performance

Suitable values for  $V_{on(RMS)}$  and  $V_{off(RMS)}$  are dependent on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at  $V_{th(off)}$ ) and the other at 90 % relative transmission (at  $V_{th(on)}$ ), see Figure 6. For a good contrast performance, the following rules should be followed:

$$V_{on(RMS)} \ge V_{th(on)} \tag{4}$$

$$V_{off(RMS)} \le V_{th(off)} \tag{5}$$

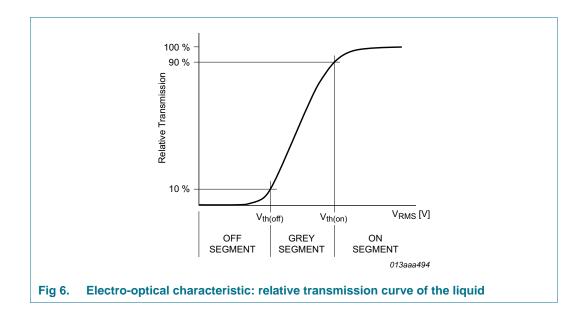
 $V_{on(RMS)}$  and  $V_{off(RMS)}$  are properties of the display driver and are affected by the selection of a (see Equation 1), n (see Equation 3), and the  $V_{LCD}$  voltage.

 $V_{th(off)}$  and  $V_{th(on)}$  are properties of the LCD liquid and can be provided by the module manufacturer.  $V_{th(off)}$  is sometimes named  $V_{th}$ .  $V_{th(on)}$  is sometimes named saturation voltage  $V_{sat}$ .

It is important to match the module properties to those of the driver in order to achieve optimum performance.

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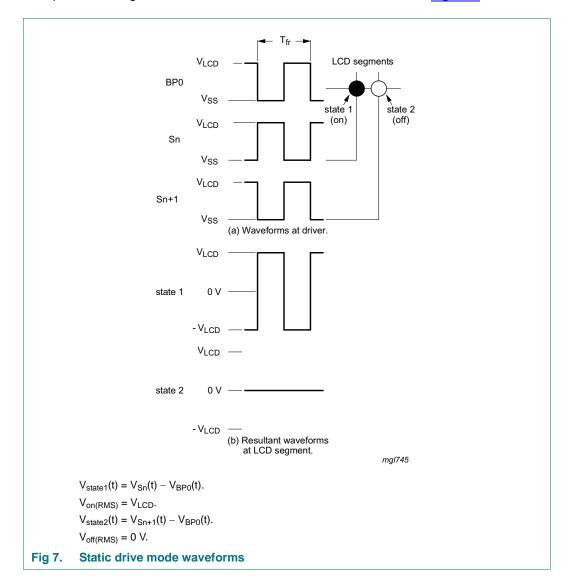


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#### 7.4 LCD drive mode waveforms

## 7.4.1 Static drive mode

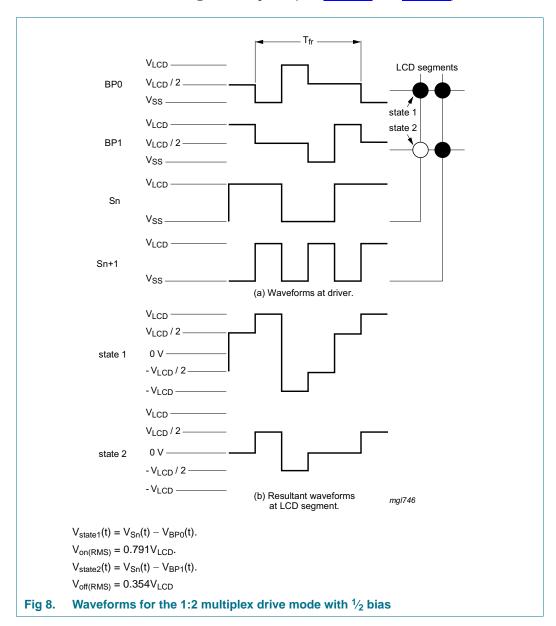
The static LCD drive mode is used when a single backplane is provided in the LCD. Backplane and segment drive waveforms for this mode are shown in Figure 7.



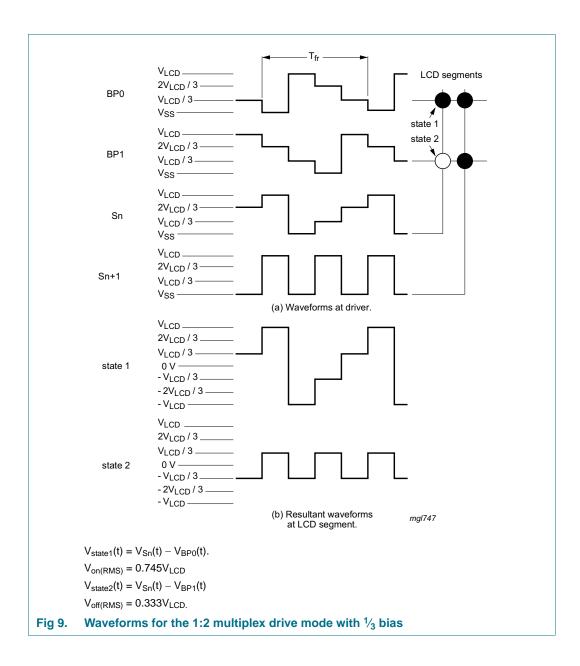
## Automotive LCD driver for low multiplex rates

## 7.4.2 1:2 Multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCA8576C allows the use of  $\frac{1}{2}$  bias or  $\frac{1}{3}$  bias (see Figure 8 and Figure 9).



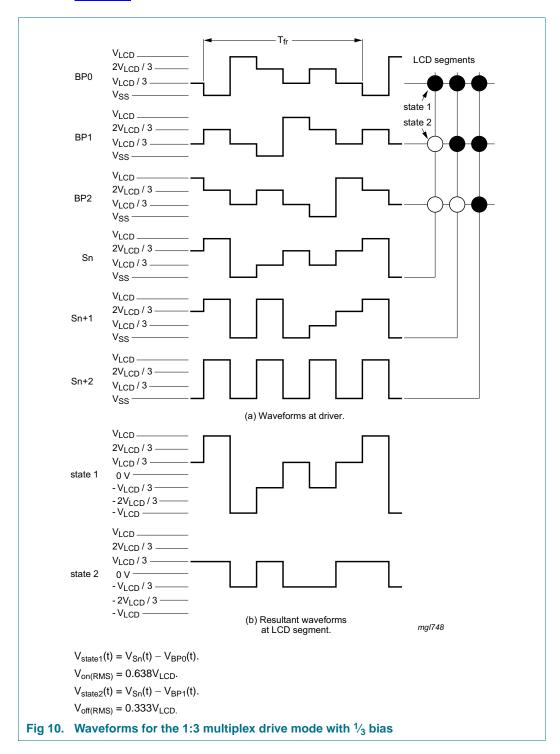
## Automotive LCD driver for low multiplex rates



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## 7.4.3 1:3 Multiplex drive mode

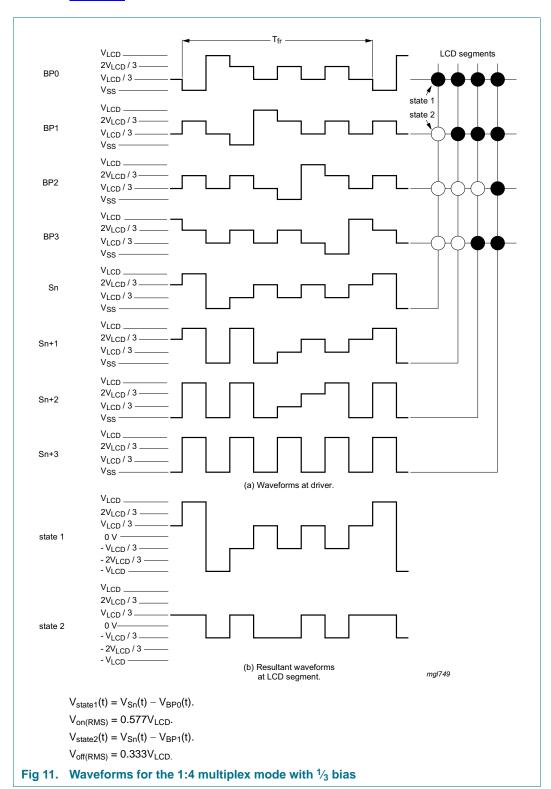
When three backplanes are provided in the LCD, the 1:3 multiplex drive mode applies as shown in Figure 10.



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## 7.4.4 1:4 multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies, as shown in Figure 11.



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#### 7.5 Oscillator

The internal logic and the LCD drive signals of the PCA8576C are timed by the frequency  $f_{clk}$ , which equals either the built-in oscillator frequency  $f_{osc}$  or the external clock frequency  $f_{clk(ext)}$ .

The clock frequency ( $f_{clk}$ ) determines the LCD frame frequency ( $f_{fr}$ ) and the maximum rate for data reception from the I<sup>2</sup>C-bus. To allow I<sup>2</sup>C-bus transmissions at their maximum data rate of 100 kHz,  $f_{clk}$  should be chosen to be above 125 kHz.

#### 7.5.1 Internal clock

The internal oscillator is enabled by connecting pin OSC to pin V<sub>SS</sub>. In this case, the output from pin CLK is the clock signal for any cascaded PCA8576C in the system.

#### 7.5.2 External clock

Connecting pin OSC to  $V_{DD}$  enables an external clock source. Pin CLK then becomes the external clock input.

**Remark:** A clock signal must always be supplied to the device. Removing the clock, freezes the LCD in a DC state, which is not suitable for the liquid crystal.

## 7.6 Timing

The timing of the PCA8576C sequences the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. In cascaded applications, the synchronization signal (SYNC) maintains the correct timing relationship between the PCA8576Cs in the system. The timing also generates the LCD frame frequency which is derived as an integer division of the clock frequency (see Table 7). The frame frequency is set by the mode-set command (see Table 10) when an internal clock is used or by the frequency applied to the pin CLK when an external clock is used.

Table 7. LCD frame frequencies [1]

PCA8576C mode	Frame frequency	Nominal frame frequency (Hz)
Normal-power mode	$f_{fr} = \frac{f_{clk}}{2880}$	69 [2]
Power-saving mode	$f_{fr} = \frac{f_{clk}}{480}$	65 [ <u>3]</u>

- [1] The possible values for  $f_{clk}$  see <u>Table 17</u>.
- [2] For  $f_{clk} = 200 \text{ kHz}$ .
- [3] For  $f_{clk} = 31 \text{ kHz}$ .

The ratio between the clock frequency and the LCD frame frequency depends on the power mode in which the device is operating. In the power-saving mode the reduction ratio is six times smaller; this allows the clock frequency to be reduced by a factor of six. The reduced clock frequency results in a significant reduction in power consumption.

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The lower clock frequency has the disadvantage of increasing the response time when large amounts of display data are transmitted on the I<sup>2</sup>C-bus. When a device is unable to process a display data byte before the next one arrives, it holds the SCL line LOW until the first display data byte is stored. This slows down the transmission rate of the I<sup>2</sup>C-bus but no data loss occurs.

### 7.7 Display register

The display register holds the display data while the corresponding multiplex signals are generated.

## 7.8 Shift register

The shift register transfers display information from the display RAM to the display register while previous data is displayed.

### 7.9 Segment outputs

The LCD drive section includes 40 segment outputs, S0 to S39, which must be connected directly to the LCD. The segment output signals are generated based on the multiplexed backplane signals and with data residing in the display register. When less than 40 segment outputs are required, the unused segment outputs should be left open-circuit.

### 7.10 Backplane outputs

The LCD drive section includes four backplane outputs: BP0 to BP3. The backplane output signals are generated based on the selected LCD drive mode.

In 1:4 multiplex drive mode: BP0 to BP3 must be connected directly to the LCD.

If less than four backplane outputs are required the unused outputs can be left as an open-circuit.

- In 1:3 multiplex drive mode: BP3 carries the same signal as BP1, therefore these two adjacent outputs can be tied together to give enhanced drive capabilities.
- In 1:2 multiplex drive mode: BP0 and BP2, BP1 and BP3 respectively carry the same signals and can also be paired to increase the drive capabilities.
- In static drive mode: the same signal is carried by all four backplane outputs and they can be connected in parallel for very high drive requirements.

#### 7.11 Display RAM

The display RAM is a static  $40 \times 4$ -bit RAM which stores LCD data.

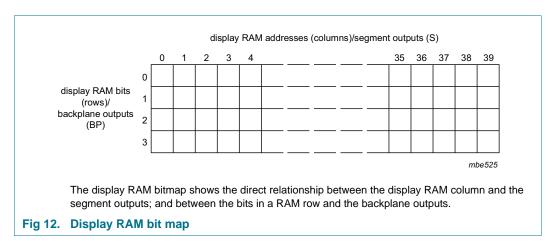
There is a one-to-one correspondence between

- the bits in the RAM bitmap and the LCD elements
- the RAM columns and the segment outputs
- the RAM rows and the backplane outputs.

A logic 1 in the RAM bitmap indicates the on-state of the corresponding LCD element; similarly, a logic 0 indicates the off-state.

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The display RAM bit map <u>Figure 12</u> shows the rows 0 to 3 which correspond with the backplane outputs BP0 to BP3, and the columns 0 to 39 which correspond with the segment outputs S0 to S39. In multiplexed LCD applications the segment data of the first, second, third and fourth row of the display RAM are time-multiplexed with BP0, BP1, BP2, and BP3 respectively.



When display data is transmitted to the PCA8576C, the display bytes received are stored in the display RAM in accordance with the selected LCD drive mode. The data is stored as it arrives and does not wait for an acknowledge cycle as with the commands. Depending on the current multiplex drive mode, data is stored singularly, in pairs, triples or quadruples. To illustrate the filling order, an example of a 7-segment numeric display showing all drive modes is given in <a href="Figure 13">Figure 13</a>; the RAM filling organization depicted applies equally to other LCD types.

The following applies to Figure 13:

- In the static drive mode, the eight transmitted data bits are placed in row 0 of eight successive 4-bit RAM words.
- In the 1:2 multiplex mode, the eight transmitted data bits are placed in pairs into row 0 and 1 of four successive 2-bit RAM words.
- In the 1:3 multiplex mode, the eight bits are placed in triples into row 0, 1, and 2 to
  three successive 3-bit RAM words, with bit 3 of the third address left unchanged. It is
  not recommended to use this bit in a display because of the difficult addressing. This
  last bit may, if necessary, be controlled by an additional transfer to this address but
  care should be taken to avoid overwriting adjacent data because always full bytes are
  transmitted.
- In the 1:4 multiplex mode, the eight transmitted data bits are placed in quadruples into row 0, 1, 2, and 3 of two successive 4-bit RAM words.

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drive mode	LCD segments	LCD backplanes	display RAM filling order	transmitted display byte
static	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	BP0	columns display RAM address/segment outputs (s) byte1  rows display RAM 0 c b a f g e d DP	MSB LSB
	S <sub>n+5</sub> - e c S <sub>n</sub> S <sub>n+7</sub>		rows/backplane 1 outputs (BP) 1 x x x x x x x x x x x x x x x x x x	c b a f g e d DP
1:2 multiplex	$S_n$ $\xrightarrow{a}$ $\xrightarrow{b}$ $S_{n+1}$ $\xrightarrow{f}$ $\xrightarrow{g}$ $S_{n+2}$ $\xrightarrow{d}$ $\xrightarrow{d}$ $\xrightarrow{DP}$	BP0 BP1	Columns   Colu	MSB LSB
1:3 multiplex	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	BP0  BP1  BP2	Columns   display RAM address/segment outputs (s)   byte1   byte2   byte3	MSB LSB
1:4 multiplex	$S_n$ $\xrightarrow{a}$ $\xrightarrow{b}$ $\xrightarrow{g}$ $S_{n+1}$ $\xrightarrow{d}$ $\xrightarrow{d}$ $\xrightarrow{DP}$	BP0 BP2 BP3	Columns   display RAM address/segment outputs (s)   byte1   byte2   byte3   byte4   byte5	MSB LSB

x = data bit unchanged.

Fig 13. Relationship between LCD layout, drive mode, display RAM filling order, and display data transmitted over the I<sup>2</sup>C-bus

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## 7.12 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the load-data-pointer command (see <u>Table 11</u>). After this, the data byte is stored starting at the display RAM address indicated by the data pointer (see <u>Figure 13</u>). Once each byte is stored, the data pointer is automatically incremented based on the selected LCD configuration.

The contents of the data pointer are incremented as follows:

- In static drive mode by eight.
- In 1:2 multiplex drive mode by four.
- In 1:3 multiplex drive mode by three.
- In 1:4 multiplex drive mode by two.

If an I<sup>2</sup>C-bus data access terminates early, the state of the data pointer is unknown. Consequently, the data pointer must be rewritten prior to further RAM accesses.

#### 7.13 Sub-address counter

The storage of display data is conditioned by the contents of the subaddress counter. Storage is allowed to take place only when the contents of the subaddress counter match with the hardware subaddress applied to A0, A1 and A2. The subaddress counter value is defined by the device-select command (see <u>Table 12</u>). If the contents of the subaddress counter and the hardware subaddress do not match then data storage is blocked but the data pointer will be incremented as if data storage had taken place. The subaddress counter is also incremented when the data pointer overflows.

The storage arrangements described lead to extremely efficient data loading in cascaded applications. When a series of display bytes are sent to the display RAM, automatic wrap-over to the next PCA8576C occurs when the last RAM address is exceeded. Subaddressing across device boundaries is successful even if the change to the next device in the cascade occurs within a transmitted character.

#### 7.14 Bank selector

#### 7.14.1 Output bank selector

The output bank selector (see <u>Table 13</u>), selects one of the four rows per display RAM address for transfer to the display register. The actual row selected depends on the LCD drive mode in operation and on the instant in the multiplex sequence.

- In 1:4 multiplex mode: all RAM addresses of row 0 are selected, followed sequentially by the contents of row 1, row 2, and then row 3.
- In 1:3 multiplex mode: rows 0, 1, and 2 are selected sequentially.
- In 1:2 multiplex mode: rows 0 and 1 are selected.
- In the static mode: row 0 is selected.

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The PCA8576C includes a RAM bank switching feature in the static and 1:2 multiplex drive modes. In the static drive mode, the bank-select command may request the contents of row 2 to be selected for display instead of the contents of row 0. In 1:2 multiplex drive mode, the contents of rows 2 and 3 may be selected instead of rows 0 and 1. This enables preparation of display information in an alternative bank and the ability to switch to it once it has been assembled.

#### 7.14.2 Input bank selector

The input bank selector (see <u>Table 13</u>) loads display data into the display RAM based on the selected LCD drive configuration. Using the bank-select command, display data can be loaded in row 2 into static drive mode or in rows 2 and 3 into 1:2 multiplex drive mode. The input bank selector functions independently of the output bank selector.

## 7.15 Blinking

The display blinking capabilities of the PCA8576C are very versatile. The whole display can be blinked at frequencies selected by the blink-select command. The blinking frequencies are integer fractions of the clock frequency; the ratios between the clock and blinking frequencies depend on the mode in which the device is operating (see <a href="Table 8">Table 8</a>).

Table 8. Blir	k freq	uencies
---------------	--------	---------

Blinking mode	Normal-power mode ratio	Power-saving mode ratio	Blink frequency
off	-	-	blinking off
1	$f_{blink} = \frac{f_{clk}}{92160}$	$f_{blink} = \frac{f_{clk}}{15360}$	2 Hz
2	$f_{blink} = \frac{f_{clk}}{184320}$	$f_{blink} = \frac{f_{clk}}{30720}$	1 Hz
3	$f_{blink} = \frac{f_{clk}}{368640}$	$f_{blink} = \frac{f_{clk}}{61440}$	0.5 Hz

An additional feature is for an arbitrary selection of LCD segments to be blinked. This applies to the static and 1:2 multiplex drive modes and can be implemented without any communication overheads. Using the output bank selector, the displayed RAM banks are exchanged with alternate RAM banks at the blinking frequency. This mode can also be specified by the blink-select command (see Table 14).

In the 1:3 and 1:4 multiplex modes, where no alternate RAM bank is available, groups of LCD segments can be blinked by selectively changing the display RAM data at fixed time intervals.

If the entire display needs to be blinked at a frequency other than the nominal blink frequency, this can be done using the mode-set command to set and reset the display enable bit E at the required rate (see Table 10).

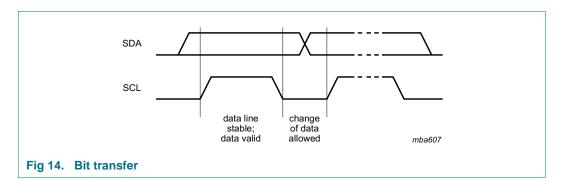
#### 7.16 Characteristics of the I<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

#### Automotive LCD driver for low multiplex rates

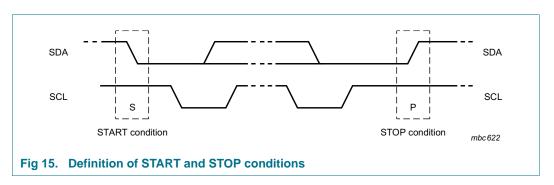
#### 7.16.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse. Changes in the data line at this time will be interpreted as a control signal. Bit transfer is illustrated in Figure 14.



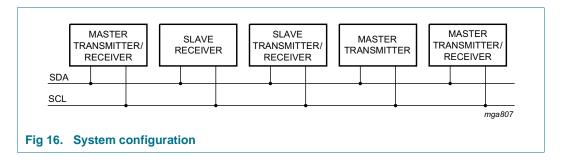
#### 7.16.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW change of the data line, while the clock is HIGH, is defined as the START condition (S). A LOW-to-HIGH change of the data line, while the clock is HIGH, is defined as the STOP condition (P). The START and STOP conditions are illustrated in Figure 15.



#### 7.16.3 System configuration

A device generating a message is a transmitter and a device receiving a message is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves. The system configuration is illustrated in Figure 16.



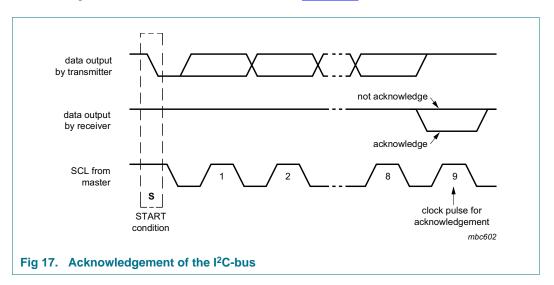
#### **Automotive LCD driver for low multiplex rates**

#### 7.16.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge cycle.

- A slave receiver, which is addressed, must generate an acknowledge after the reception of each byte.
- A master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

Acknowledgement on the I<sup>2</sup>C-bus is illustrated in Figure 17.



#### 7.16.5 PCA8576C I<sup>2</sup>C-bus controller

The PCA8576C acts as an  $I^2$ C-bus slave receiver. It does not initiate  $I^2$ C-bus transfers or transmit data to an  $I^2$ C-bus master receiver. The only data output from the PCA8576C are the acknowledge signals of the selected devices. Device selection depends on the  $I^2$ C-bus slave address, the transferred command data and the hardware subaddress.

In single device application, the hardware subaddress inputs A0, A1, and A2 are normally tied to  $V_{SS}$  which defines the hardware subaddress 0. In multiple device applications A0, A1, and A2 are tied to  $V_{SS}$  or  $V_{DD}$  using a binary coding scheme so that no two devices with a common  $I^2C$ -bus slave address have the same hardware subaddress.

#### **Automotive LCD driver for low multiplex rates**

In the power-saving mode it is possible that the PCA8576C is not able to keep up with the highest transmission rates when large amounts of display data are transmitted. If this situation occurs, the PCA8576C forces the SCL line LOW until its internal operations are completed. This is known as the clock synchronization feature of the I<sup>2</sup>C-bus and serves to slow down fast transmitters. Data loss does not occur.

#### 7.16.6 Input filter

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

## 7.17 I<sup>2</sup>C-bus protocol

Two  $I^2C$ -bus slave addresses (0111000 and 0111001) are reserved for the PCA8576C. The least significant bit of the slave address that a PCA8576C responds to is defined by the level tied at its input SA0. Therefore, two types of PCA8576C can be distinguished on the same  $I^2C$ -bus which allows:

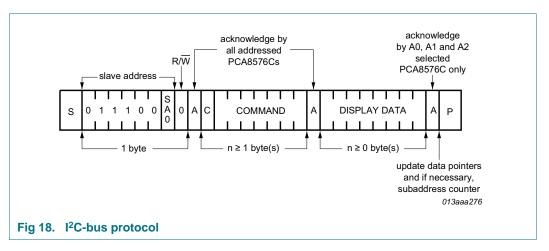
- Up to 16 PCA8576Cs on the same I<sup>2</sup>C-bus for very large LCD applications.
- The use of two types of LCD multiplex on the same I<sup>2</sup>C-bus.

The  $I^2C$ -bus protocol is shown in <u>Figure 18</u>. The sequence is initiated with a START condition (S) from the  $I^2C$ -bus master which is followed by one of the two PCA8576C slave addresses available. All PCA8576Cs with the corresponding SA0 level acknowledge in parallel with the slave address but all PCA8576Cs with the alternative SA0 level ignore the whole  $I^2C$ -bus transfer.

After acknowledgement, one or more command bytes follow which define the status of the addressed PCA8576Cs.

The last command byte is tagged with a cleared most significant bit, the continuation bit C. The command bytes are also acknowledged by all addressed PCA8576Cs on the bus.

After the last command byte, a series of display data bytes may follow. These display bytes are stored in the display RAM at the address specified by the data pointer and the subaddress counter. Both data pointer and subaddress counter are automatically updated and the data is directed to the intended PCA8576C device. The acknowledgement after each byte is made only by the (A0, A1, and A2) addressed PCA8576C. After the last display byte, the I<sup>2</sup>C-bus master issues a STOP condition (P).

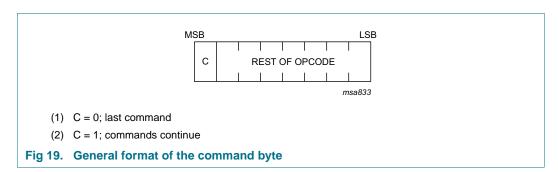


PCA8576C

## Automotive LCD driver for low multiplex rates

#### 7.18 Command decoder

The command decoder identifies command bytes that arrive on the I<sup>2</sup>C-bus. All available commands carry a continuation bit C in their most significant bit position as shown in Figure 19. When this bit is set logic 1, it indicates that the next byte of the transfer to arrive will also represent a command. If this bit is set logic 0, it indicates that the command byte is the last in the transfer. Further bytes will be regarded as display data.



The five commands available to the PCA8576C are defined in Table 9.

Table 9. Definition of PCA8576C commands

Command	Opera	Operation Code							Reference
Bit	7	6	5	4	3	2	1	0	
mode-set	С	1	0	LP	Е	В	M[1:0]		Section 7.18.1
load-data-pointer	С	0	P[5:0] <u>Section 7.18.2</u>						
device-select	С	1	1 0 0 A[2:0] <u>Section 7.18.3</u>				Section 7.18.3		
bank-select	С	1	1	1	1	0	I	0	Section 7.18.4
blink-select	С	1	1	1	0	AB	BF[1:0	)]	Section 7.18.5

## 7.18.1 Mode-set command

Table 10. Mode-set command bit description

Bit	Symbol	Value	Description
7	С	0, 1	see Figure 19
6 to 5	-	10	fixed value
4	LP		power dissipation (see <u>Table 7</u> )
		0	normal-power mode
		1	power-saving mode
3	Е		display status
		0	disabled[1]
		1	enabled
2	В		LCD bias configuration <sup>[2]</sup>
		0	¹⅓ bias
		1	½ bias

## Automotive LCD driver for low multiplex rates

Table 10. Mode-set command bit description ...continued

Bit	Symbol	Value	Description
1 to 0	M[1:0]		LCD drive mode selection
		01	static; BP0
		10	1:2 multiplex; BP0, BP1
		11	1:3 multiplex; BP0, BP1, BP2
		00	1:4 multiplex; BP0, BP1, BP2, BP3

<sup>[1]</sup> The possibility to disable the display allows implementation of blinking under external control.

## 7.18.2 Load-data-pointer command

Table 11. Load-data-pointer command bit description

Bit	Symbol	Value	Description
7	С	0, 1	see Figure 19
6	-	0	fixed value
5 to 0	P[5:0]	000000 to 100111	6 bit binary value, 0 to 39; transferred to the data pointer to define one of forty display RAM addresses

#### 7.18.3 Device-select command

Table 12. Device-select command bit description

Bit	Symbol	Value	Description
7	С	0, 1	see Figure 19
6 to 4	-	1100	fixed value
3 to 0	A[2:0]	000 to 111	3 bit binary value, 0 to 7; transferred to the subaddress counter to define one of eight hardware subaddresses

#### 7.18.4 Bank-select command

Table 13. Bank-select command bit description

Bit	Symbol	Value	Description					
			Static 1:2 multiplex[1]					
7	С	0, 1	see Figure 19					
6 to 2	-	11110	fixed value					
1	Į		input bank selection; storage of arriving display data					
		0	RAM bit 0	RAM bits 0 and 1				
		1	RAM bit 2	RAM bits 2 and 3				
0	0		output bank selection; retriev	al of LCD display data				
		0	RAM bit 0	RAM bits 0 and 1				
		1	RAM bit 2	RAM bits 2 and 3				

<sup>[1]</sup> The bank-select command has no effect in 1:3 and 1:4 multiplex drive modes.

<sup>[2]</sup> Bit B is not applicable for the static LCD drive mode.

## **Automotive LCD driver for low multiplex rates**

#### 7.18.5 Blink-select command

Table 14. Blink-select command bit description

Bit	Symbol	Value	Description
7	С	0, 1	see Figure 19
6 to 3	-	1110	fixed value
2	AB		blink mode selection
		0	normal blinking[1]
		1	alternate RAM bank blinking[2]
1 to 0	BF[1:0]		blink frequency selection
		00	off
		01	1
		10	2
		11	3

<sup>[1]</sup> Normal blinking is assumed when the LCD multiplex drive modes 1:3 or 1:4 are selected.

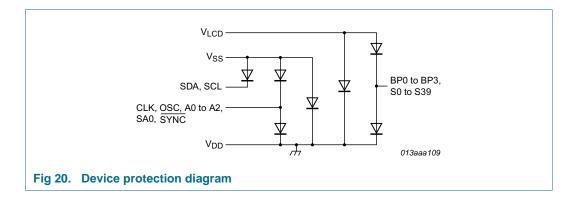
## 7.19 Display controller

The display controller executes the commands identified by the command decoder. It contains the status registers of the PCA8576C and coordinates their effects. The controller is also responsible for loading display data into the display RAM as required by the filling order.

<sup>[2]</sup> Alternate RAM bank blinking does not apply in 1:3 and 1:4 multiplex drive modes.

## Automotive LCD driver for low multiplex rates

## 8. Internal circuitry



## 9. Safety notes

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### **CAUTION**



Static voltages across the liquid crystal display can build up when the LCD supply voltage  $(V_{LCD})$  is on while the IC supply voltage  $(V_{DD})$  is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

## Automotive LCD driver for low multiplex rates

## 10. Limiting values

Table 15. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+8.0	V
$V_{LCD}$	LCD supply voltage	[1]	$V_{DD}-8.0$	$V_{DD}$	V
Vı	input voltage	on each of the pins SCL, SDA, CLK, SYNC, SA0, OSC and A0 to A2	-0.5	+8.0	V
Vo	output voltage	on each of the pins [1] S0 to S39 and BP0 to BP3	-0.5	+8.0	V
l <sub>l</sub>	input current		-20	+20	mA
lo	output current		-25	+25	mA
I <sub>DD</sub>	supply current		-50	+50	mA
I <sub>SS</sub>	ground supply current		-50	+50	mA
I <sub>DD(LCD)</sub>	LCD supply current		-50	+50	mA
P <sub>tot</sub>	total power dissipation		-	400	mW
Po	output power		-	100	mW
$V_{ESD}$	electrostatic discharge voltage	HBM [2]	-	±4000	V
		CDM [3]			·
		PCA8576CH			
		all pins	-	500	V
		corner pins	-	1000	V
		PCA8576CT			
		all pins	-	500	V
		corner pins	-	750	V
I <sub>lu</sub>	latch-up current	[4]	-	150	mA
T <sub>stg</sub>	storage temperature	[5]	-65	+150	°C
T <sub>amb</sub>	ambient temperature	operating device	-40	+85	°C

<sup>[1]</sup> Values with respect to  $V_{DD}$ .

<sup>[2]</sup> Pass level; Human Body Model (HBM), according to Ref. 6 "JESD22-A114".

<sup>[3]</sup> Pass level; Charged-Device Model (CDM), according to Ref. 7 "JESD22-C101".

<sup>[4]</sup> Pass level; latch-up testing according to Ref. 8 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub>).

<sup>[5]</sup> According to the store and transport requirements (see Ref. 10 "UM10569") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

## **Automotive LCD driver for low multiplex rates**

## 11. Static characteristics

#### Table 16. Static characteristics

 $V_{DD}$  = 2.0 V to 6.0 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  =  $V_{DD}$  - 6.0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supplies			-			
$V_{DD}$	supply voltage		2.0	-	6.0	V
$V_{LCD}$	LCD supply voltage	[1]	$V_{DD}-6.0$	-	V <sub>DD</sub> – 2.0	V
I <sub>DD</sub>	supply current:	$f_{clk} = 200 \text{ kHz}$ [2]	-	-	120	μΑ
$I_{DD(Ip)}$	low-power mode supply current	$V_{DD}$ = 3.5 V; $V_{LCD}$ = 0 V; $f_{clk}$ = 35 kHz; A0, A1 and A2 connected to $V_{SS}$	-	-	60	μΑ
Logic						
V <sub>IL</sub>	LOW-level input voltage	on pins CLK, SYNC, OSC, A0 to A2 and SA0	V <sub>SS</sub>	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage	on pins CLK, SYNC, OSC, A0 to A2 and SA0	0.7V <sub>DD</sub>	-	$V_{DD}$	V
$V_{OL}$	LOW-level output voltage	I <sub>OL</sub> = 0 mA	-	-	0.05	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = 0 mA	$V_{DD}-0.05$	-	-	V
I <sub>OL</sub>	LOW-level output current	output sink current; $V_{OL} = 1.0 \text{ V}; V_{DD} = 5.0 \text{ V};$ on pins CLK and SYNC	1	-	-	mA
IL	leakage current	$V_I = V_{DD}$ or $V_{SS}$ ; on pins CLK, SCL, SDA, A0 to A2 and SA0	-1	-	+1	μΑ
I <sub>L(OSC)</sub>	leakage current on pin OSC	$V_I = V_{DD}$	-1	-	+1	μΑ
I <sub>pd</sub>	pull-down current	V <sub>I</sub> = 1.0 V; V <sub>DD</sub> = 5.0 V; on pins A0 to A2 and OSC	15	50	150	μΑ
R <sub>SYNC_N</sub>	SYNC resistance		20	50	150	kΩ
$V_{POR}$	power-on reset voltage	[3]	-	1.0	1.6	V
Cı	input capacitance	[4]	-	-	7	pF
I <sup>2</sup> C-bus;	oins SDA and SCL					
V <sub>IL</sub>	LOW-level input voltage		$V_{SS}$	-	$0.3V_{DD}$	V
V <sub>IH</sub>	HIGH-level input voltage		0.7V <sub>DD</sub>	-	6.0	V
I <sub>OH(CLK)</sub>	HIGH-level output current on pin CLK	output source current; V <sub>OH</sub> = 4.0 V; V <sub>DD</sub> = 5.0 V	1	-	-	mA
I <sub>OL(SDA)</sub>	LOW-level output current on pin SDA	output sink current; V <sub>OL</sub> = 0.4 V; V <sub>DD</sub> = 5.0 V	3	-	-	mA

## **Automotive LCD driver for low multiplex rates**

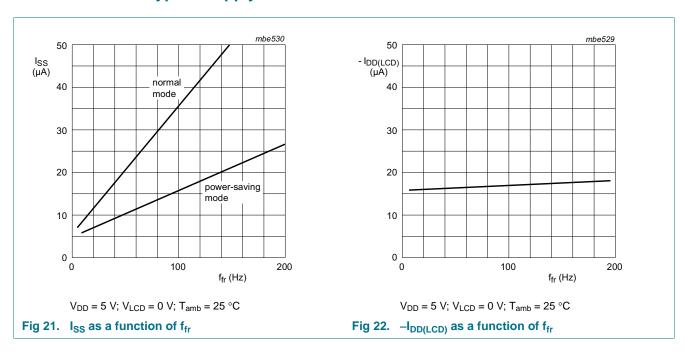
Table 16. Static characteristics ... continued

 $V_{DD}$  = 2.0 V to 6.0 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  =  $V_{DD}$  - 6.0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

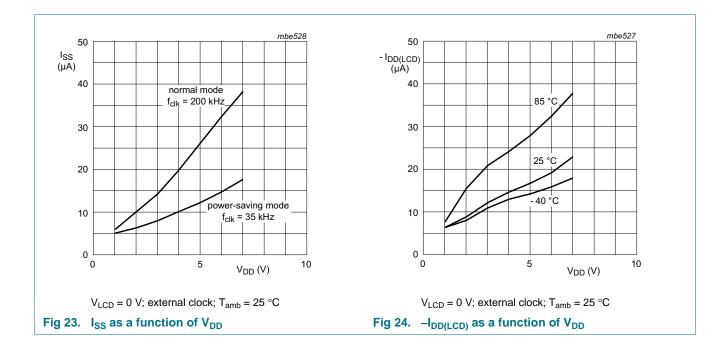
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
LCD outp	uts					
$V_{BP}$	voltage on pin BP	C <sub>bpl</sub> = 35 nF; on pins BP0 to BP3	-20	-	+20	mV
Vs	voltage on pin S	C <sub>sgm</sub> = 5 nF; on pins S0 to S39	-20	-	+20	mV
R <sub>BP</sub>	resistance on pin BP	$V_{LCD} = V_{DD} - 5 \text{ V}$ ; on pins BP0 to BP3 [5]	-	-	5	kΩ
R <sub>S</sub>	resistance on pin S	$V_{LCD} = V_{DD} - 5 \text{ V}$ ; on pins S0 to S39 [5]	-	-	7.5	kΩ

- [1]  $V_{LCD} \le V_{DD} 3 \text{ V for } \frac{1}{3} \text{ bias.}$
- [2] LCD outputs are open-circuit; inputs at V<sub>SS</sub> or V<sub>DD</sub>; external clock with 50 % duty factor; I<sup>2</sup>C-bus inactive.
- [3] Resets all logic when  $V_{DD} < V_{POR}$ .
- [4] Periodically sampled, not 100 % tested.
- [5] Outputs measured one at a time.

## 11.1 Typical supply current characteristics

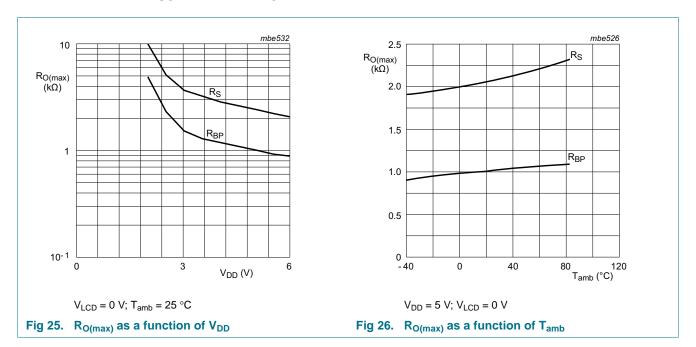


## Automotive LCD driver for low multiplex rates



## **Automotive LCD driver for low multiplex rates**

## 11.2 Typical LCD output characteristics



## **Automotive LCD driver for low multiplex rates**

## 12. Dynamic characteristics

Table 17. Dynamic characteristics

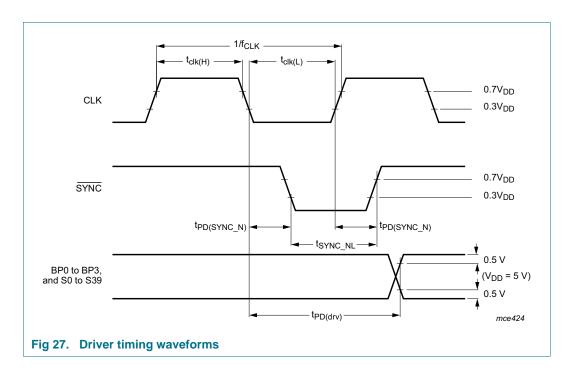
 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 6.5 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

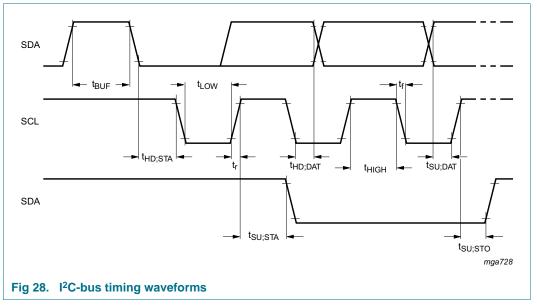
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Timing cha	racteristics: driver timing waveforms (see	Figure 27)				
f <sub>clk</sub>	clock frequency	normal-power mode; [1] $V_{DD} = 5 \text{ V}$	125	200	315	kHz
		power-saving mode; V <sub>DD</sub> = 3 V	21	31	48	kHz
t <sub>clk(H)</sub>	clock HIGH time		1	-	-	μS
t <sub>clk(L)</sub>	clock LOW time		1	-	-	μS
t <sub>PD(SYNC_N)</sub>	SYNC propagation delay		-	-	400	ns
t <sub>SYNC_NL</sub>	SYNC LOW time		1	-	-	μS
t <sub>PD(drv)</sub>	driver propagation delay	$V_{LCD} = 5 V$	-	-	30	μS
Timing cha	racteristics: I <sup>2</sup> C-bus (see Figure 28)[2]			·	·	
t <sub>BUF</sub>	bus free time between a STOP and START condition		4.7	-	-	μS
t <sub>HD;STA</sub>	hold time (repeated) START condition		4.0	-	-	μS
t <sub>SU;STA</sub>	set-up time for a repeated START condition		4.7	-	-	μS
t <sub>LOW</sub>	LOW period of the SCL clock		4.7	-	-	μS
t <sub>HIGH</sub>	HIGH period of the SCL clock		4.0	-	-	μS
t <sub>r</sub>	rise time of both SDA and SCL signals		-	-	1	μS
t <sub>f</sub>	fall time of both SDA and SCL signals		-	-	0.3	μS
C <sub>b</sub>	capacitive load for each bus line		-	-	400	pF
t <sub>SU;DAT</sub>	data set-up time		250	-	-	ns
t <sub>HD;DAT</sub>	data hold time		0	-	-	ns
t <sub>SU;STO</sub>	set-up time for STOP condition		4.0	-	-	μS

<sup>[1]</sup>  $f_{clk} <$  125 kHz, I<sup>2</sup>C-bus maximum transmission speed is derated.

<sup>[2]</sup> All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V<sub>IL</sub> and V<sub>IH</sub> with an input voltage swing of V<sub>SS</sub> to V<sub>DD</sub>.

## Automotive LCD driver for low multiplex rates





#### Automotive LCD driver for low multiplex rates

# 13. Application information

### 13.1 Cascaded operation

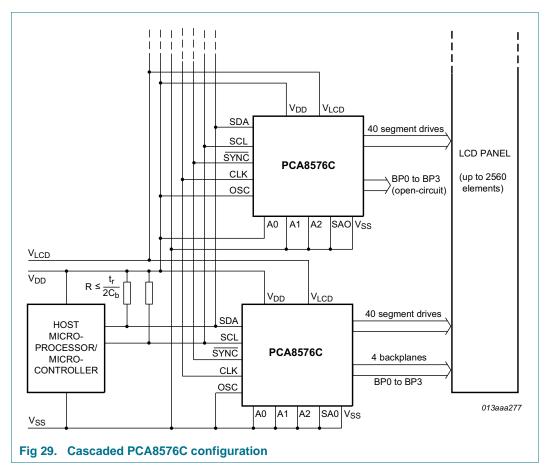
In large display configurations, up to 16 PCA8576Cs can be recognized on the same  $I^2C$ -bus by using the 3-bit hardware subaddress (A0, A1 and A2) and the programmable  $I^2C$ -bus slave address (SA0).

Table 18. Addressing cascaded PCA8576C

Cluster	Bit SA0	Pin A2	Pin A1	Pin A0	Device
1	0	0	0	0	0
		0	0	1	1
		0	1	0	2
		0	1	1	3
		1	0	0	4
		1	0	1	5
		1	1	0	6
		1	1	1	7
2	1	0	0	0	8
		0	0	1	9
		0	1	0	10
		0	1	1	11
		1	0	0	12
		1	0	1	13
		1	1	0	14
		1	1	1	15

Cascaded PCA8576Cs are synchronized. They can share the backplane signals from one of the devices in the cascade. Such an arrangement is cost-effective in large LCD applications since the backplane outputs of only one device need to be through-plated to the backplane electrodes of the display. The other PCA8576C of the cascade contribute additional segment outputs. The backplanes can either be connected together to enhance the drive capability, some can be left open-circuit (as shown in <a href="Figure 29">Figure 29</a>) or just some of one and some of the other device can be taken to facilitate the layout of the display.

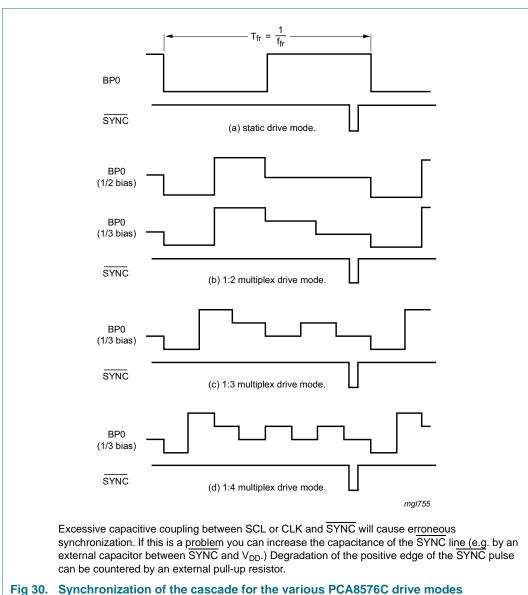
#### Automotive LCD driver for low multiplex rates



The SYNC line is provided to maintain the correct synchronization between all cascaded PCA8576Cs. This synchronization is guaranteed after the power-on reset. The only time that SYNC is likely to be needed is if synchronization is accidentally lost (e.g. by noise in adverse electrical environments; or by the defining a multiplex mode when PCA8576Cs with differing SA0 levels are cascaded).

SYNC is organized as an input/output pin; the output selection being realized as an open-drain driver with an internal pull-up resistor. A PCA8576C asserts the SYNC line and monitors the SYNC line at all other times. If synchronization in the cascade is lost, it is restored by the first PCA8576C to assert SYNC. The timing relationship between the backplane waveforms and the SYNC signal for the various drive modes of the PCA8576C are shown in Figure 30.

# **Automotive LCD driver for low multiplex rates**



#### Tig 30. Synchronization of the cascade for the various r CA03700 drive modes

# 14. Test information

### 14.1 Quality information

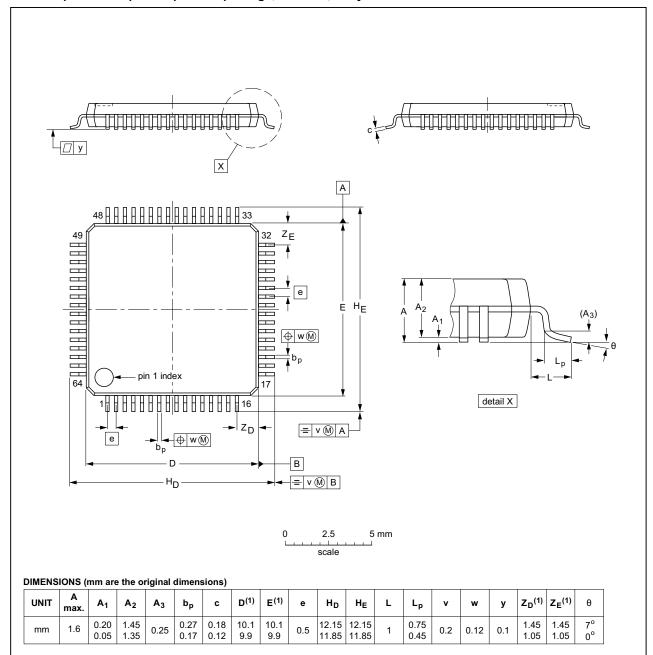
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

### Automotive LCD driver for low multiplex rates

# 15. Package outline

LQFP64: plastic low profile quad flat package; 64 leads; body 10 x 10 x 1.4 mm

SOT314-2



#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT314-2	136E10	MS-026				<del>00-01-19</del> 03-02-25	

Fig 31. Package outline SOT314-2 (LQFP64) of PCA8576CH

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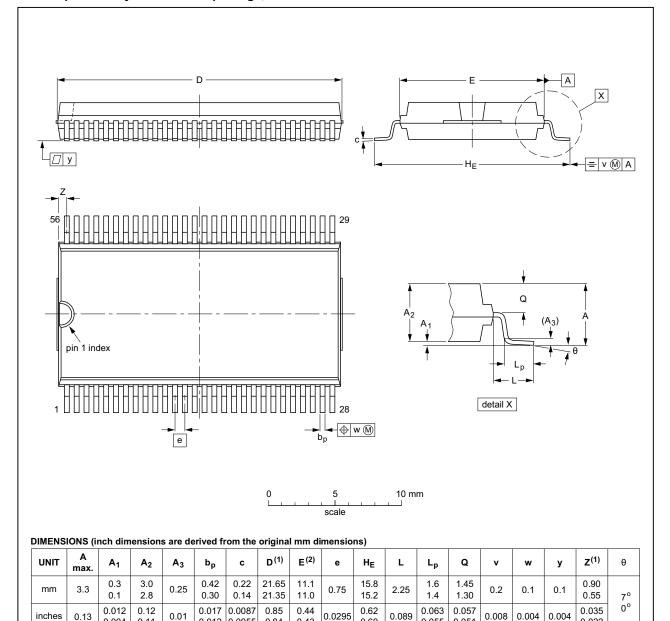
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**PCA8576C NXP Semiconductors** 

#### **Automotive LCD driver for low multiplex rates**

#### VSO56: plastic very small outline package; 56 leads

#### SOT190-1



0.004

1. Plastic or metal protrusions of 0.3 mm (0.012 inch) maximum per side are not included.

0.012 0.0055

0.84

0.43

2. Plastic interlead protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

		EUROPEAN	ISSUE DATE			
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
					<del>97-08-11</del> 03-02-19	
	IEC	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA	IEC JEDEC JEHA	

0.60

0.055

0.051

Fig 32. Package outline SOT190-1 (VSO56) of PCA8576CT/1

PCA8576C

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0.022

#### Automotive LCD driver for low multiplex rates

# 16. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

# 17. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

## 17.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

## 17.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

#### Automotive LCD driver for low multiplex rates

### 17.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

### 17.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 33</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 19 and 20

Table 19. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350	≥ 350			
< 2.5	235	220			
≥ 2.5	220	220			

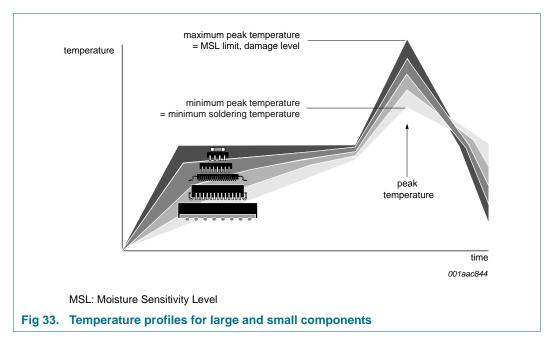
Table 20. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)						
	Volume (mm <sup>3</sup> )	lume (mm³)					
	< 350	350 to 2000	> 2000				
< 1.6	260	260	260				
1.6 to 2.5	260	250	245				
> 2.5	250	245	245				

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 33.

### Automotive LCD driver for low multiplex rates



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

**NXP Semiconductors** 

# 18.1 LCD segment driver selection

Table 21. Selection of LCD segment drivers

Type name	Nun	Number of elements at MUX							V <sub>DD</sub> (V) V <sub>LCD</sub> (V)	f <sub>fr</sub> (Hz)	V <sub>LCD</sub> (V)	V <sub>LCD</sub> (V)	T <sub>amb</sub> (°C)	Interface	Package	AEC-
	1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.				Q100
PCA8553DTT	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256[1]	N	N	-40 to 105	I <sup>2</sup> C / SPI	TSSOP56	Υ
PCA8546ATT	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>11</sup>	N	N	-40 to 95	I <sup>2</sup> C	TSSOP56	Υ
PCA8546BTT	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[1]</sup>	N	N	-40 to 95	SPI	TSSOP56	Υ
PCA8547AHT	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[1]</sup>	Υ	Υ	-40 to 95	I <sup>2</sup> C	TQFP64	Υ
PCA8547BHT	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[1]</sup>	Υ	Υ	-40 to 95	SPI	TQFP64	Υ
PCF85134HL	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 6.5	82	N	N	-40 to 85	I <sup>2</sup> C	LQFP80	N
PCA85134H	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 8	82	N	N	-40 to 95	I <sup>2</sup> C	LQFP80	Υ
PCA8543AHL	60	120	-	240	-	-	-	2.5 to 5.5	2.5 to 9	60 to 300 <sup>[1]</sup>	Υ	Υ	-40 to 105	I <sup>2</sup> C	LQFP80	Υ
PCF8545ATT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300 <sup>[1]</sup>	N	N	-40 to 85	I <sup>2</sup> C	TSSOP56	N
PCF8545BTT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300[1]	N	N	-40 to 85	SPI	TSSOP56	N
PCF8536AT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 85	I <sup>2</sup> C	TSSOP56	N
PCF8536BT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 85	SPI	TSSOP56	N
PCA8536AT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95	I <sup>2</sup> C	TSSOP56	Υ
PCA8536BT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95	SPI	TSSOP56	Υ
PCF8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 85	I <sup>2</sup> C	TQFP64	N
PCF8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 85	SPI	TQFP64	N
PCA8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95	I <sup>2</sup> C	TQFP64	Υ
PCA8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95	SPI	TQFP64	Υ
PCA9620H	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 105	I <sup>2</sup> C	LQFP80	Υ
PCA9620U	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 105	I <sup>2</sup> C	Bare die	Υ
PCF8576DU	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	N	-40 to 85	I <sup>2</sup> C	Bare die	N
PCF8576EUG	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	N	-40 to 85	I <sup>2</sup> C	Bare die	N
PCA8576FUG	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	200	N	N	-40 to 105	I <sup>2</sup> C	Bare die	Υ
PCF85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 6.5	82, 110 <sup>[2]</sup>	N	N	-40 to 85	I <sup>2</sup> C	Bare die	N
PCA85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	82, 110 <sup>[2]</sup>	N	N	-40 to 95	I <sup>2</sup> C	Bare die	Υ

Table 21. Selection of LCD segment drivers ...continued

Ту	pe name	Number of elements at MUX				V <sub>DD</sub> (V)	$V_{DD}(V) V_{LCD}(V) f_{fr}(Hz)$		V <sub>LCD</sub> (V) V <sub>LCD</sub> (V)		T <sub>amb</sub> (°C)	Interface	Package	AEC-			
		1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.				Q100
PC	CA85233UG	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	150, 220[2]	N	N	-40 to 105	I <sup>2</sup> C	Bare die	Υ
PC	F85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90[1]	N	N	-40 to 85	I <sup>2</sup> C	Bare die	N
PC	CA8530DUG	102	204	-	408	-	-	-	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 105	I <sup>2</sup> C / SPI	Bare die	Υ
PC	CA85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90[1]	N	N	-40 to 95	I <sup>2</sup> C	Bare die	Υ
PC	CA85232U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	117 to 176[1]	N	N	-40 to 95	I <sup>2</sup> C	Bare die	Υ
PC	F8538UG	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 85	I <sup>2</sup> C / SPI	Bare die	N
PC	CA8538UG	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 105	I <sup>2</sup> C / SPI	Bare die	Υ

<sup>[1]</sup> Software programmable.

Hardware selectable.

#### **Automotive LCD driver for low multiplex rates**

## 19. Abbreviations

Table 22. Abbreviations

Acronym	Description
AEC	Automotive Electronics Council
CDM	Charged-Device Model
DC	Direct Current
HBM	Human Body Model
I <sup>2</sup> C	Inter-Integrated Circuit
IC	Integrated Circuit
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MM	Machine Model
MOS	Metal-Oxide Semiconductor
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
PCB	Printed-Circuit Board
POR	Power-On Reset
RC	Resistance-Capacitance
RAM	Random Access Memory
RMS	Root Mean Square
SCL	Serial CLock line
SDA	Serial DAta line
SMD	Surface-Mount Device

# 20. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN11267 EMC and system level ESD design guidelines for LCD drivers
- [3] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [4] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [5] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [6] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [7] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [8] JESD78 IC Latch-Up Test
- [9] UM10204 I<sup>2</sup>C-bus specification and user manual
- [10] UM10569 Store and transport requirements

# Automotive LCD driver for low multiplex rates

# 21. Revision history

#### Table 23. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA8576C v.3	20150408	Product data sheet	-	PCA8576C v.2
Modifications:	The format of this of NXP Semiconc	data sheet has been redes luctors.	signed to comply with the	new identity guidelines
	<ul> <li>Legal texts have l</li> </ul>	peen adapted to the new co	ompany name where app	ropriate.
	<ul> <li>Fixed typo</li> </ul>			
PCA8576C v.2	20131216	Product data sheet	-	PCA8576C v.1
PCA8576C v.1	20100722	Product data sheet	-	-

#### **Automotive LCD driver for low multiplex rates**

# 22. Legal information

#### 22.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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